ANADIGICS

AWT6244

HELP3™ TD-SCDMA

Linear Power Amplifier Module
Data Sheet- Rev 2.0

FEATURES

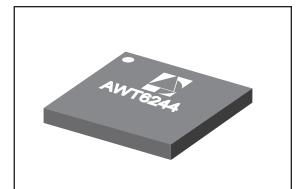
- InGAP HBT Technology
- · Single mode control input
- Internal Voltage Regulator eliminates need for external Reference Voltage (VREF)
- Low Leakage Current in Shutdown Mode: <1 μA
- Optimized for a 50 Ω System
- Low Profile RoHS Compliant Package, 250 °C MSL-3

TD-SCDMA MODE

- 38% @ Pout = +27.5 dBm
- 22% @ Pout = +16 dBm (without DC/DC Convert

APPLICATIONS

- · Wireless Handsets and Data Devices for
 - TD-SCDMA 1.8/2.0 GHz bands



M27 Package
10 Pin 3 mm x 3 mm x 1 mm
Surface Mount Module

PRODUCT DESCRIPTION

The AWT6244 HELP3[™] PA is a next generation product for TD-SCDMA handsets. This PA incorporates ANADIGICS' HELP3[™] technology to provide low power consumption without the need for an external voltage regulator or DC/DC Converter. The AWT6244 is manufactured on an advanced InGaP HBT MMIC technology offering state-of-the-art reliability, temperature stability, and ruggedness. There are two

operating modes for optimum efficiency at high and medium/low power output levels with a single mode input. A shutdown mode with low leakage current increases handset talk and standby-time. The self-contained 3 mm x 3 mm x 1 mm surface mount package incorporates matching networks optimized for output power, efficiency, and linearity in a 50 Ω system.

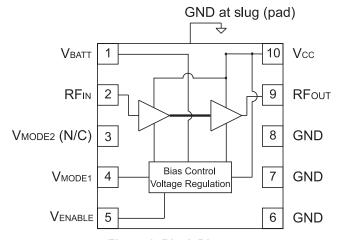


Figure 1: Block Diagram

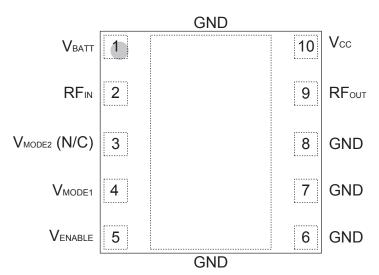


Figure 2: Pinout (X-ray Top View)

Table 1: Pin Description

PIN	NAME	DESCRIPTION
1	V_{BATT}	Battery Voltage
2	RFℕ	RF Input
3	V _{MODE2} (N/C)	No Connection
4	V _{MODE1}	Mode Control Voltage 1
5	VENABLE	PA Enable Voltage
6	GND	Ground
7	GND	Ground
8	GND	Ground
9	RFout	RF Output
10	Vcc	Supply Voltage

ELECTRICAL CHARACTERISTICS

Table 2: Absolute Minimum and Maximum Ratings

PARAMETER	MIN	MAX	UNIT
Supply Voltage (Vcc)	0	+5	V
Battery Voltage (VBATT)	0	+6	V
Control Voltages (VMODE1, VENABLE)	0	+3.5	V
RF Input Power (Pℕ)	i	+10	dBm
Storage Temperature (Tstg)	-40	+150	°C

Stresses in excess of the absolute ratings may cause permanent damage. Functional operation is not implied under these conditions. Exposure to absolute ratings for extended periods of time may adversely affect reliability.

Table 3: Operating Ranges

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
Operating Frequency (f)	1880 2010	1 1	1920 2025	MHz	TD-SCDMA Band TD-SCDMA Band
Supply Voltage (Vcc)	+3.2	+3.4	+4.2	٧	Роит <u><</u> +28.5 dBm
Enable Voltage (VENABLE)	+2.15 0	+2.4	+3.1 +0.5	V	PA "on" PA "shut down"
Mode Control Voltage (VMODE1)	+2.15 0	+2.4	+3.1 +0.5	V	Low Bias Mode High Bias Mode
RF Output Power (Pour), TD-SCDMA TD-SCDMA (HPM) TD-SCDMA (LPM)	27 15.5	27.5 16.0	27.5 16.0	dBm	3GPP TS 25.102 Section 6.2.1
Case Temperature (Tc)	-20	-	+90	°C	

The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

Notes:

(1) For operation at Vcc = +3.2 V, Pout is derated by 0.5 dB.



Table 4: Electrical Specifications - TD-SCDMA Mode (Tc = +25 °C, Vcc = +3.4 V, Vbatt = +3.4 V, Venable = +2.4 V, 50 Ω system)

PARAMETER	MIN	TYP MAX		UNIT	COMMENTS	
PARAMETER	IVIIIN	ITP	IVIAA	UNII	Роит	V _{MODE1}
Gain	24.0 11.5	27 13.5	30.0 16.5	dB	+27.5 dBm +16 dBm	0 V 2.4 V
ACLR1 at 1.6 MHz offset	1 1	-42 -42	-38 -38	dBc	+27.5 dBm +16 dBm	0 V 2.4 V
ACLR2 at 3.2 MHz offset	1 1	-55 -55	-48 -48	dBc	+27.5 dBm +16 dBm	0 V 2.4 V
Power-Added Efficiency (without DC/DC Converter)	35 14	38 20	1 1	%	+27.5 dBm +16 dBm	0 V 2.4 V
Quiescent Current (lcq) Low Bias Mode	1	8	13	mA	V _{MODE1} = +2.4 V	
Mode Control Current	1	0.3	0.8	mA	through V _{MODE} pin, V _{MODE1} = +2.4 V	
Enable Current	-	0.3	0.8	mA	through Venable pin, Ven = +2.4 V	
BATT Current	-	3.0	5	mA	through VBATT pin, VMODE1 = +2.4 V	
Leakage Current	1	<1	5	μΑ	V _{BATT} = +4.3 V, V _{CC} = +4.3 V, V _{ENABLE} = 0 V, V _{MODE1} = 0 V	
Noise Figure	1	TBD	1	dB	$P_{OUT} \le +27.5 \text{ dBm}, V_{MODE} = 0 \text{ V}$	
Noise rigule	-	TBD	-	dB	Pout ≤ 16 dBm, V _{MODE} = +2.4 V	
Harmonics 2fo 3fo, 4fo	-	1 1	-35 -35	dBc	Роит <u><</u> +27.5 dBm	
Input Impedance	-	-	2:1	VSWR		
Load mismatch stress with no permanent degradation or failure	8:1	-	-	VSWR	Applies over full operating range	

Transmit off Power: -91 dBm Dynamic Range: 122 dB

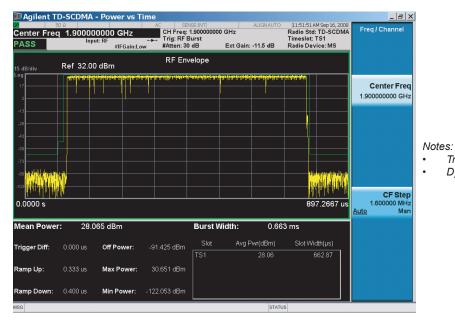


Fig 3: Transmit off power @ 1.9GHz (Freq = 1900 MHz, Pout = 28 dBm, Vcc = 3.4 V, Tc = 25 °C)

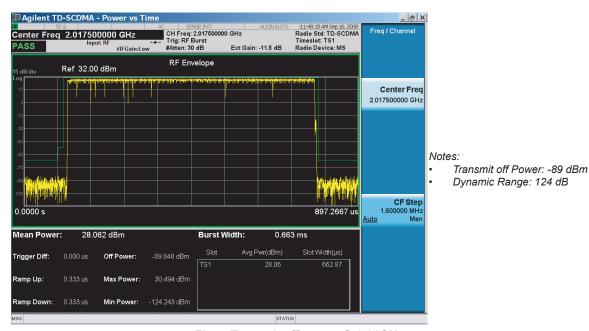


Fig 4: Transmit off power @ 2.01GHz (Freq = 2017.5 MHz, Pout = 28 dBm, Vcc = 3.4 V, Tc = 25 $^{\circ}$ C)

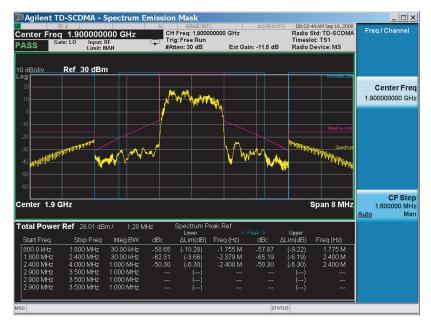


Fig 5: Spectrum Emission Mask @ 2.01GHz (Freq = 1900 MHz, Pouτ = 28 dBm, Vcc = 3.4 V, Tc = 25 °C)

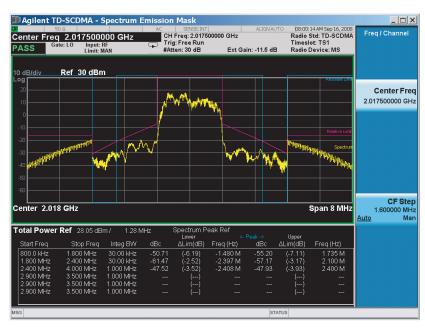


Fig 6: Spectrum Emission Mask @ 1.9GHz (Freq = 2017.5 MHz, Poυτ = 28 dBm, Vcc = 3.4 V, Tc = 25 °C)

Table 5: Electrical Specifications - UMTS/WCDMA Mode (Tc = +25 °C, Vcc = +3.4 V, Vbatt = +3.4 V, Venable = +2.4 V, 50 Ω system)

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS		
PARAMETER	IVIIIV	111	IVIAA	UNII	Роит	V _{MODE1}	
Gain	25.0 12.0	27.5 14.0	30.0 16.5	dB	+28.5 dBm +17 dBm	0 V 2.4 V	
ACLR1 at 1.6 MHz offset (1)	1 1	-38 -38	-36 -36	dBc	+28.5 dBm +17 dBm	0 V 2.4 V	
ACLR2 at 3.2 MHz offset	1 1	-55 -55	-48 -48	dBc	+28.5 dBm +17 dBm 0 V 2.4 V		
Power-Added Efficiency (1) (without DC/DC Converter)	36 16	40 20	1 1	%	+28.5 dBm +17 dBm	0 V 2.4 V	
Quiescent Current (lcq) Low Bias Mode	1	8	13	mA	V _{MODE1} = +2.4 V		
Mode Control Current	-	0.3	0.8	mA	through V _{MODE} pin, V _{MODE1} = +2.4 V		
Enable Current	-	0.3	8.0	mA	through Venable pin, Ven = +2.4 V		
BATT Current	-	3.0	5	mA	through VBATT pin, VMODE1 = +2.4 V		
Leakage Current		<1	5	μΑ	V _{BATT} = +4.3 V, V _{CC} = +4.3 V, V _{ENABLE} = 0 V, V _{MODE1} = 0 V		

Notes:

⁽¹⁾ ACLR and Efficiency measured at 1950 MHz.

^{2.}POUT ≤ +28.5 dBm; In-band load VSWR < 5:1; Out-of-band load VSWR < 10:1; Applies over all operating conditions.

APPLICATION INFORMATION

To ensure proper performance, refer to all related Application Notes on the ANADIGICS web site: http://www.anadigics.com

Shutdown Mode

The power amplifier may be placed in a shutdown mode by applying logic low levels (see Operating Ranges table) to the VENABLE and VMODE1 voltages.

Bias Modes

The power amplifier may be placed in either a Low Bias mode or a High Bias mode by applying the appropriate

logic level (see Operating Ranges table) to V_{MODE1} . The Bias Control table lists the recommended modes of operation for various applications. V_{MODE2} is not necessary for this PA.

Two operating modes are available to optimize current consumption. High Bias/High Power operating mode is for Pout levels \geq 16 dBm. At around 16 dBm output power, the PA should be "Mode Switched" to Medium/Low power mode for lowest quiescent current consumption.

Table 6: Bias Control (TD-SCDMA)

APPLICATION	Роит Levels	BIAS MODE	VENABLE	VMODE1	V cc	V BATT
TD-SCDMA-med/low power (Low Bias Mode)	≤ + 16 dBM	Low	+2.4 V	+2.4 V	3.2- 4.2 V	≧ 3.2 V
TD-SCDMA-high power (High Bias Mode)	> +15 dBm	High	+2.4 V	0 V	3.2- 4.2 V	≧ 3.2 V
Shutdown	-	Shutdown	0 V	0 V	3.2 - 4.2 V	≧ 3.2 V

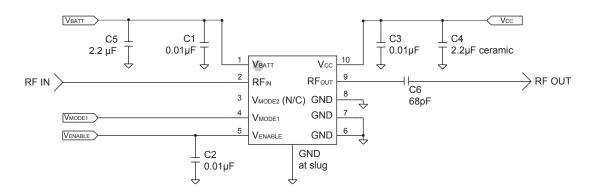
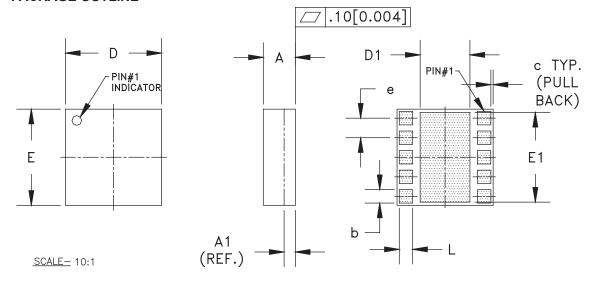


Figure 7: Application Circuit Schematic

PACKAGE OUTLINE



SYMBOL	MI	LLIMETER	RS		INCHES		NOTE
FO _L	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.91	1.01	1.11	0.035	0.039	0.043	_
A1	0.35 (REF.)			0.0	014 (RE	F.)	_
b	0.33	-	0.52	0.013	_	0.020	3
С	-	0.10	_	-	0.004	-	-
D	2.88	3.00	3.12	0.113	0.118	0.123	-
D1	1.57	-	1.82	0.062	-	0.072	3
Е	2.88	3.00	3.12	0.113	0.118	0.123	-
E1	2.75	_	2.85	0.108	_	0.112	3
е	0.61				0.024		3
L	0.33	_	0.52	0.013	_	0.020	3

NOTES:

- 1. CONTROLLING DIMENSIONS: MILLIMETERS
- 1. CONTROLLING DIMENSIONS: MILLIMETERS
 2. UNLESS SPECIFIED TOLERANCE=±0.076[0.003].
 3. PADS (INCLUDING CENTER) SHOWN UNIFORM SIZE FOR REFERENCE ONLY.
 ACTUAL PAD SIZE AND LOCATION WILL VARY WITHIN MIN. AND MAX. DIMENSIONS ACCORDING TO SPECIFIC LAMINATE DESIGN.
 4. UNLESS SPECIFIED DIMENSIONS ARE SYMMETRICAL ABOUT CENTER LINES SHOWN.

Figure 8: M27 Package Outline - 10 Pin 3 mm x 3 mm x 1 mm Surface Mount Module

BRAND

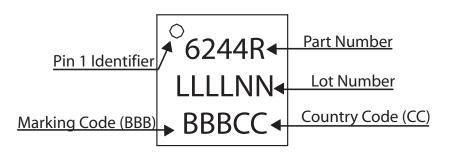
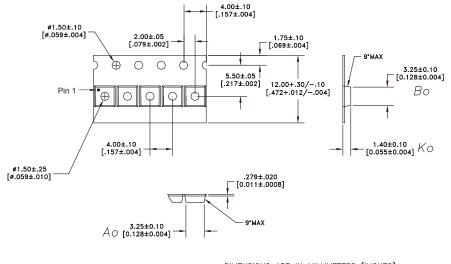


Figure 9: Branding Specification - M27 Package



COMPONENT PACKAGING



NOTES:

DIMENSIONS ARE IN MILLIMETERS [INCHES]

1. MATERIAL: 3000 (CARBON FILLED POLYCARBONATE) 100% RECYCLABLE.

DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994

Figure 10: Tape & Reel Packaging

Table 7: Tape & Reel Dimensions

PACKAGE TYPE	TAPE WIDTH	POCKET PITCH	REEL CAPACITY	MAX REEL DIA
3 mm x 3 mm x 1 mm	12 mm	4 mm	2500	7"

ORDERING INFORMATION

ORDER NUMBER	TEMPERATURE RANGE	PACKAGE DESCRIPTION	COMPONENT PACKAGING
AWT6244RM27Q7	-20 °C to +90 °C	RoHS Compliant 10 Pin 3 mm x 3 mm x 1 mm Surface Mount Module	Tape and Reel, 2500 pieces per Reel
AWT6244RM27P9	-20 °C to +90 °C	RoHS Compliant 10 Pin 3 mm x 3 mm x 1 mm Surface Mount Module	Partial Tape and Reel



ANADIGICS

141 Mount Bethel Road Warren, New Jersey 07059, U.S.A.

Tel: +1 (908) 668-5000 Fax: +1 (908) 668-5132

URL: http://www.anadigics.com

IMPORTANT NOTICE

ANADIGICS, Inc. reserves the right to make changes to its products or to discontinue any product at any time without notice. The product specifications contained in Advanced Product Information sheets and Preliminary Data Sheets are subject to change prior to a product's formal introduction. Information in Data Sheets have been carefully checked and are assumed to be reliable; however, ANADIGICS assumes no responsibilities for inaccuracies. ANADIGICS strongly urges customers to verify that the information they are using is current before placing orders.

WARNING

ANADIGICS products are not intended for use in life support appliances, devices or systems. Use of an ANADIGICS product in any such application without written consent is prohibited.

